

Features

- Collector Current: I_C= 0.6A
- Power Dissipation of 625mW



2. BASE

3. COLLECTOR

R 123 TO-92



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
KSP2222ABU	TO-92	2N2222A	1000

Maximum Ratings (Ta=25°C unless otherwise noted)

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Symbol	Parameter	Value	Unit	
V _{CBO}	Collector-Base Voltage	75	V	
V _{CEO}	Collector-Emitter Voltage	40	V	
V _{EBO}	Emitter-Base Voltage	6	V	
Ic	Collector Current -Continuous	0.6	Α	
P _D	Collector Power Dissipation	625	mW	
R _{0 JA}	Thermal Resistance from Junction to Ambient	200	°C /W	
T_J , T_{stg}	Operation Junction and Storage Temperature Range	-55~+150	$^{\circ}$	

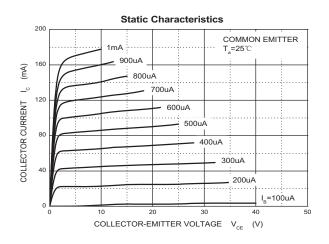
Electrical Charcteristics (Ta=25°C unless otherwise specified)

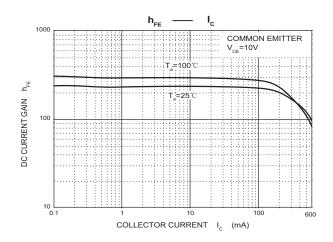
Parameter	Symbol	Test conditions	Min	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _C = 10uA , I _E =0	75		V
Collector-emitter breakdown voltage V _{(BR)CE0}		I _C = 10mA , I _B =0	40		V
Emitter-base breakdown voltage	V _{(BR)EBO}	$V_{(BR)EBO}$ $I_E=10uA, I_C=0$			V
Collector cut-off current	I _{CBO}	V _{CB} = 60V, I _E =0		10	nA
Collector cut-off current	I _{CEX}	V _{CE} = 60V,V _{EB(Off)} =3V		10	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 3 V, I _C =0		100	nA
DC current gain	h _{FE(1)}	V _{CE} =10V,I _C = 150mA	100	300	
	h _{FE(2)}	V _{CE} =10V,I _C = 0.1mA	40		
	h _{FE(3)} *	V _{CE} =10V, I _C = 500mA	42		
	V _{CE(sat)(1)} *	I _C = 500mA, I _B =50mA		0.6	V
Collector-emitter saturation voltage	V _{CE(sat)(2)} *	I _C = 150mA, I _B =15mA		0.3	V
Base-emitter saturation voltage	V _{BE(sat)} *	I _C = 500mA, I _B = 50mA		1.2	V
Delay time	t _d	V _{CC} =30V, V _{EB(Off)} =-0.5V,		10	nS
Rise time	t _r	I _C =150mA,I _{B1} =15mA		25	nS
Storage time	t _S	V30V Ic-150mA II15mA		225	nS
Fall time	t _f	V _{CC} =30V,Ic=150mA,I _{B1} =I _{B2} =15mA 60		60	nS
Transition frequency	f⊤	V _{CE} =20V, I _C =20mA, f=100MHz 300		MHz	

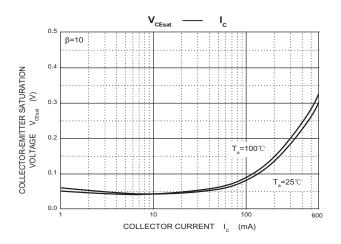
*pulse test

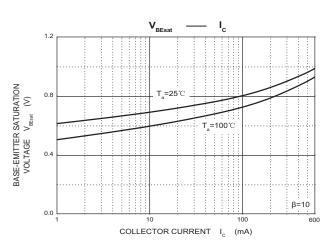


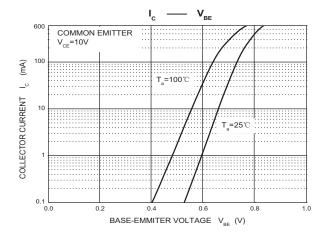
Typical Characteristics

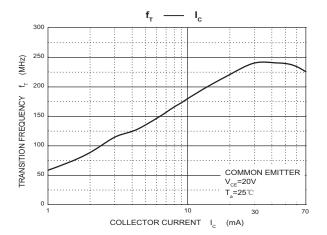


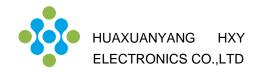


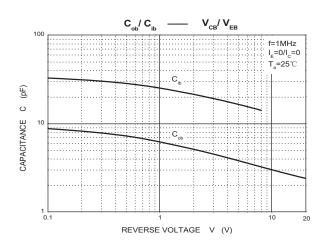


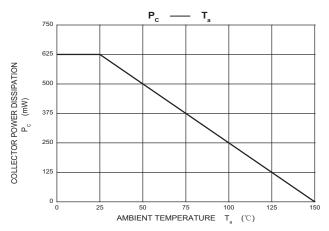




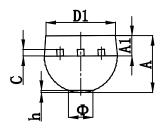


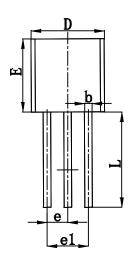






TO-92(TO-92-3) Package Outline Dimensions





Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
Α	3.300	3.700	0.130	0.146
A1	1.100	1.400	0.043	0.055
b	0.380	0.550	0.015	0.022
С	0.360	0.510	0.014	0.020
D	4.300	4.700	0.169	0.185
D1	3.430		0.135	
Е	4.300	4.700	0.169	0.185
е	1.270 TYP		0.050 TYP	
e1	2.440	2.640	0.096	0.104
L	14.100	14.500	0.555	0.571
Ф		1.600		0.063
h	0.000	0.380	0.000	0.015



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